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Standard for Manufacturing and Supply Chain Traceability of Electronic Products

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Standard for Manufacturing and Supply Chain Traceability of Electronic Products

Developed by the Critical Components Traceability Task Group (2-19a)
of the Electronic Product Data Description Committee (2-10) of IPC

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Users of this publication are encouraged to participate in the
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Standard for Manufacturing and Supply Chain Traceability of Electronic Products

1 SCOPE

This standard establishes minimum requirements for manufacturing and supply chain traceability based on perceived risk. This standard applies to all products, processes, assemblies, parts, components, equipment used and other items as defined by users and suppliers in the manufacture of printed board assemblies, as well as mechanical assembly and printed board fabrication. This standard is applicable both for internal traceability (i.e., traceability within the environment in which the product is assembled) and external traceability (i.e., as products and materials are moved between locations as part of their supply chain).

Minimum requirements are based on four levels of traceability for materials and processes. These levels can correlate to the IPC Product Classification System (Class 1, Class 2, Class 3 and Space/Defense/Medical) and/or another set of categories of compliance, based on the business model/economic needs of the end-use market for the final product (e.g., telecom, aerospace, automotive, medical device, consumer electronics) or a subassembly within that product.

1.1 Purpose Historically, the lack of a uniform component traceability standard has caused an unnecessary consumption of resources (e.g., time, people, money) to track events or parts to their sources and to remedy any quality, reliability, etc., issues. Lack of a standard has also made it difficult to uniformly create and appropriately enforce the necessary contracts.

The traceability information detailed in this standard is intended to improve operational efficiency and productivity, quality and reliability as well as to enable activities such as predictive maintenance in the manufacturing environment but not necessarily to be distributed outside of the organization. This standard can help organizations more easily ensure end users / consumers will receive products and services that meet or exceed their expectations in the timeliest and most economically viable method.

This standard can also aid in reducing counterfeit components in an organization's supply chain, whether using an authorized supplier or not.

1.1.1 About This Standard and the Concept of Traceability Traceability has grown from being a specialized need for safety-critical segments of industry to a recognized tool that adds value to industry as a whole. Disparate standards that have evolved, mainly dictated by large original equipment manufacturers (OEMs), can create confusion in the market, as a multitude of requirements and definitions proliferate. The intent of this standard is to bring the whole principle of traceability up to date. Traceability, as further described in this standard, represents both the most effective quality tool available internally within assembly operations, which can become an intrinsic part of best-practice operations, as well as the traceability of packages between locations of material manufacture and product assembly, ensuring contents of transported items are not compromised (i.e., by ingress of counterfeit materials). This is accomplished with the encouragement of automated data collection from systems already integrating quality, manufacturing, engineering and supply chain, thus reducing cost of ownership and ensuring timeliness and accuracy.

The wealth of analysis data accessible from traceability can yield information that can raise expectations for very significant quality and performance improvements, as well as provide the necessary protection against the costs in the market as a result of adverse issues.

This standard creates a flexible data architecture that can be adopted to represent all levels of traceability that are required across industry. This includes support for the most demanding instances for detail and integrity (e.g., critical-safety systems) through to situations in which only basic traceability may be needed (e.g., simple consumer products). This standard presents a cellular-based structure to provide required flexibility and create an efficient format in which unnecessary duplication of data is avoided. The format also allows data to be added after the completion of production, enabling further detail to be added as it becomes available.

Throughout the design of this standard, different key usage models of traceability were considered. It is written to explain how access to critical data, when needed to identify the exact scope of any market issues, can be ensured, while also being capable of providing "live" access to detailed product-build records for advanced quality analysis.

This standard also demonstrates the benefits of best-practice data collection through automated means. This is reflected in the definitions of the different levels of traceability.